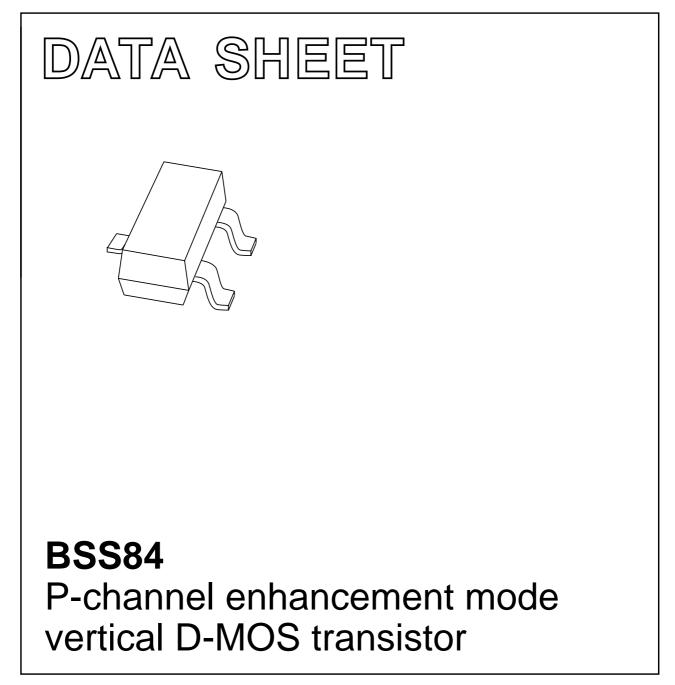
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1997 Jun 18 2003 Aug 04



FEATURES

- Low threshold voltage
- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

APPLICATIONS

- Line current interrupter in telephone sets
- Relay, high speed and line transformer drivers.

DESCRIPTION

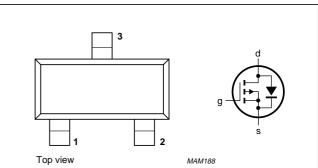
P-channel enhancement mode vertical D-MOS transistor in a SOT23 SMD package.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport and handling.

PINNING - SOT23

| PIN | SYMBOL | DESCRIPTION |
|-----|--------|-------------|
| 1 | g | gate |
| 2 | s | source |
| 3 | d | drain |



Marking code: SP

Fig.1 Simplified outline and symbol.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------|----------------------------------|---|------|------|------|------|
| V _{DS} | drain-source voltage (DC) | | - | - | -50 | V |
| V _{GSO} | gate-source voltage (DC) | open drain | - | - | ±20 | V |
| V _{GSth} | gate-source threshold voltage | $I_D = -1 \text{ mA}; V_{DS} = V_{GS}$ | -0.8 | - | -2 | V |
| I _D | drain current (DC) | | - | - | -130 | mA |
| R _{DSon} | drain-source on-state resistance | $I_D = -130 \text{ mA}; V_{GS} = -10 \text{ V}$ | - | 6 | 10 | Ω |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | - | - | 250 | mW |

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|--------------------------------|---------------------------------------|------|------|------|
| V _{DS} | drain-source voltage (DC) | | _ | -50 | V |
| V _{GSO} | gate-source voltage (DC) | open drain | _ | ±20 | V |
| I _D | drain current (DC) | | _ | -130 | mA |
| I _{DM} | peak drain current | | _ | -520 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$; note 1 | - | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | operating junction temperature | | _ | 150 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT | |
|---------------------|---|------------|-------|------|--|
| R _{th j-a} | thermal resistance from junction to ambient | note 1 | 500 | K/W | |

Note to the Limiting values and Thermal characteristics

1. Device mounted on a printed-circuit board.

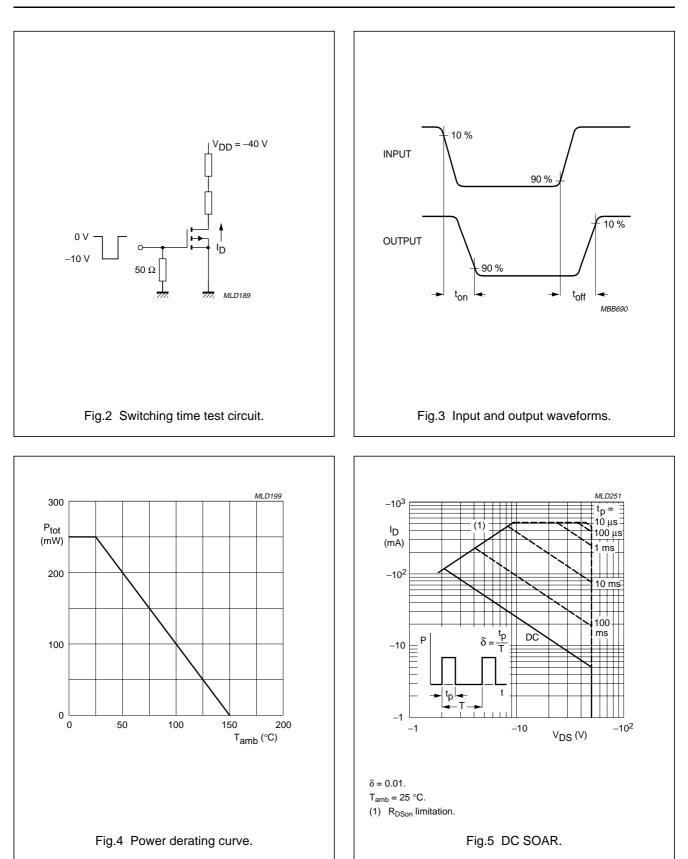
CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

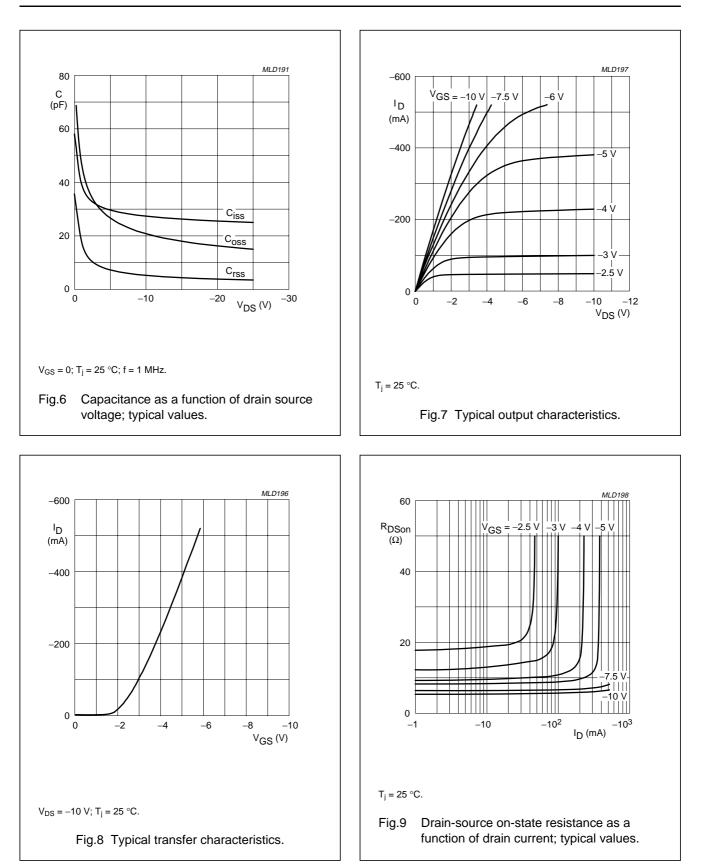
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------------------------|----------------------------------|--|------|------|------|------|
| V _{(BR)DSS} | drain-source breakdown voltage | $V_{GS} = 0; I_D = -10 \ \mu A$ | -50 | - | _ | V |
| V _{GSth} | gate-source threshold voltage | $V_{DS} = V_{GS}; I_D = -1 \text{ mA}$ | -0.8 | _ | -2 | V |
| I _{DSS} | drain-source leakage current | $V_{GS} = 0; V_{DS} = -40 V$ | _ | _ | -100 | nA |
| | | $V_{GS} = 0; V_{DS} = -50 V$ | _ | _ | -10 | μA |
| | | $V_{GS} = 0; V_{DS} = -50 \text{ V}; T_j = 125 \text{ °C}$ | _ | _ | -60 | μA |
| I _{GSS} | gate leakage current | $V_{DS} = 0; V_{GS} = \pm 20 V$ | _ | _ | ±100 | nA |
| R _{DSon} | drain-source on-state resistance | $V_{GS} = -10 \text{ V}; \text{ I}_{D} = -130 \text{ mA}$ | _ | 6 | 10 | Ω |
| y _{fs} | forward transfer admittance | $V_{DS} = -25 \text{ V}; I_D = -130 \text{ mA}$ | 50 | _ | _ | mS |
| C _{iss} | input capacitance | $V_{GS} = 0; V_{DS} = -25 V; f = 1 MHz$ | _ | 25 | 45 | pF |
| C _{oss} | output capacitance | $V_{GS} = 0; V_{DS} = -25 V; f = 1 MHz$ | _ | 15 | 25 | pF |
| C _{rss} | reverse transfer capacitance | $V_{GS} = 0; V_{DS} = -25 V; f = 1 MHz$ | _ | 3.5 | 12 | pF |
| Switching times (see Figs 2 and 3) | | | | | | |
| t _{on} | turn-on time | $V_{GS} = 0$ to -10 V; $V_{DD} = -40$ V; $I_D = -200$ mA | - | 3 | - | ns |
| t _{off} | turn-off time | $V_{GS} = -10 \text{ to } 0 \text{ V}; V_{DD} = -40 \text{ V};$ $I_D = -200 \text{ mA}$ | - | 7 | - | ns |

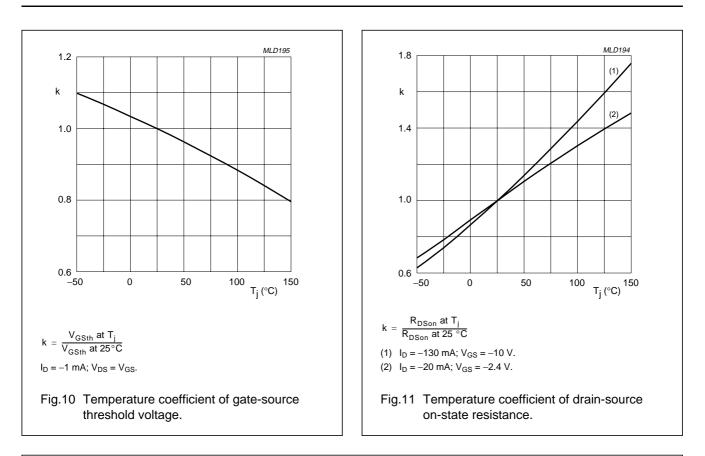
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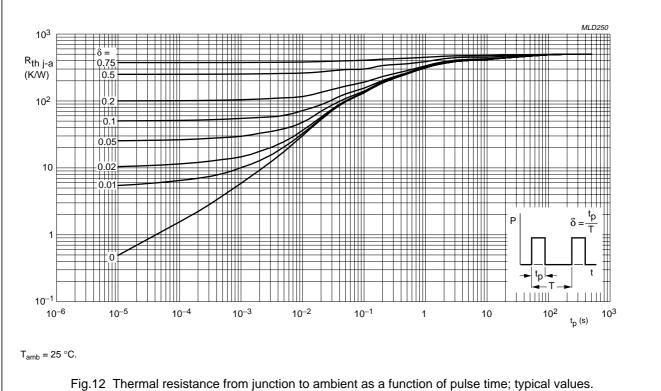
P-channel enhancement mode vertical D-MOS transistor



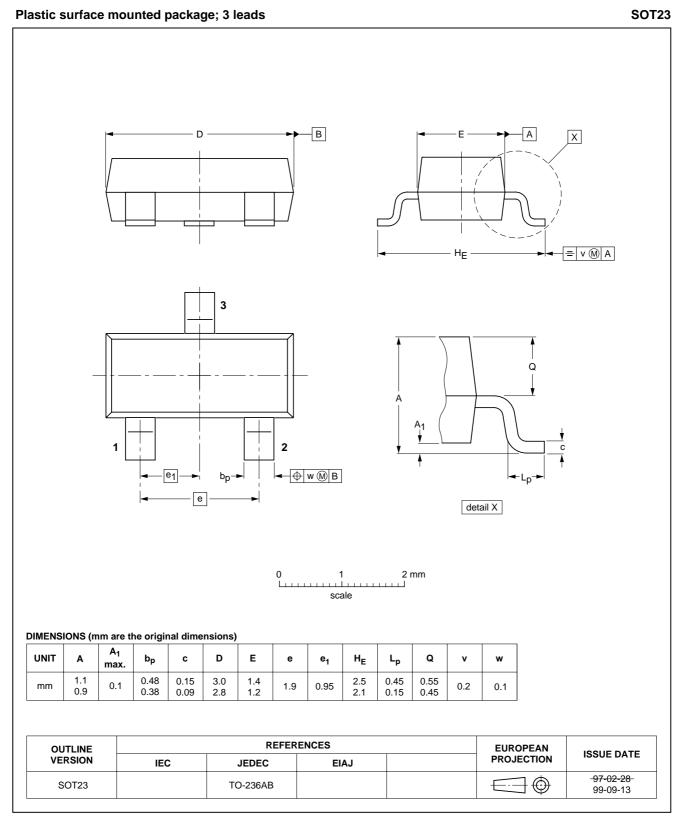
2003 Aug 04







PACKAGE OUTLINE



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DATA SHEET STATUS

| LEVEL | DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾⁽³⁾ | DEFINITION |
|-------|-------------------------------------|-------------------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| 11 | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
| | Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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